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# **HIGH-EFFICIENCY STEP-DOWN LOW POWER DC-DC CONVERTER**

#### **<sup>1</sup>FEATURES**

- **High-Efficiency Synchronous Step-Down Converter With Greater Than 95% Efficiency** • **Down-Hole Drilling**
- **2 V to 5.5 V Operating Input Voltage Range High Temperature Environments**
- **Adjustable Output Voltage Range From 0.8 V to V<sup>I</sup>**
- **Synchronizable to External Clock Signal up to** • **Controlled Baseline 1 MHz**
- **One Assembly/Test Site Up to 300 mA Output Current**
- **Pin-Programmable Current Limit**
- **High Efficiency Over a Wide Load Current Temperature Range**(1) **Range in Power Save Mode**
- **100% Maximum Duty Cycle for Lowest** • **Extended Product-Change Notification Dropout**
- **Low-Noise Operation Antiringing Switch and**
- 
- 
- **Evaluation Module Available for Commercial Temperature Range Temperature Range CONSIDER (1)** Custom temperature ranges available

## **APPLICATIONS**

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# **SUPPORTS EXTREME TEMPERATURE**

- 
- 
- **One Fabrication Site**
- **Available in Extreme (–55°C/210°C)**
- **Extended Product Life Cycle**
- 
- **Product Traceability**
- **Texas Instruments high temperature products PFM/PWM Operation Mode utilize highly optimized silicon (die) solutions** with design and process enhancements to • **50-**µ**A Quiescent Current (TYP) maximize performance over extended temperatures.**
	-

# **DESCRIPTION**

The TPS62000 device is a low-noise synchronous step-down dc-dc converter that is ideally suited for systems powered from a 1-cell Li-ion battery or from a 2- to 3-cell NiCd, NiMH, or alkaline battery. The TPS62000 operates typically down to an input voltage of 1.8 V, with a specified minimum input voltage of 2 V.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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# **DESCRIPTION (CONTINUED)**

The TPS62000 is a synchronous current-mode PWM converter with integrated N- and P-channel power MOSFET switches. Synchronous rectification is used to increase efficiency and to reduce external component count. To achieve the highest efficiency over a wide load current range, the converter enters a power-saving pulse-frequency modulation (PFM) mode at light load currents. Operating frequency is typically 750 kHz, allowing the use of small inductor and capacitor values. The device can be synchronized to an external clock signal in the range of 500 kHz to 1 MHz. For low-noise operation, the converter can be operated in the PWM mode and the internal antiringing switch reduces noise and EMI. In the shutdown mode, the current consumption is reduced to less than 1 µA. The TPS62000-HT is available in the 10-pin (HKK). The dvice operates a free-air temperature range of  $-55\hat{A}^{\circ}C$  to 210 $\hat{A}^{\circ}C$ .



#### **AVAILABLE OPTIONS(1)**



(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

(2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).



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# **FUNCTIONAL BLOCK DIAGRAM**



- A. The adjustable output voltage version does not use the internal feedback resistor divider. The FB pin is directly connected to the error amplifier.
- B. Do not connect the FC pin to an external power source

#### **PIN FUNCTIONS**





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# **BARE DIE INFORMATION**



Origin



#### **Bond Pad Coordinates in Microns - Rev A**









# **DETAILED DESCRIPTION**

#### **Operation**

The TPS62000 is a step down converter operating in a current mode PFM/PWM scheme with a typical switching frequency of 750 kHz.

At moderate to heavy loads, the converter operates in the pulse width modulation (PWM) and at light loads the converter enters a power save mode (pulse frequency modulation) to keep the efficiency high.

In the PWM mode operation, the part operates at a fixed frequency of 750 kHz. At the beginning of each clock cycle, the high side P-channel MOSFET is turned on. The current in the inductor ramps up and is sensed via an internal circuit. The high side switch is turned off when the sensed current causes the PFM/PWM comparator to trip when the output voltage is in regulation or when the inductor current reaches the current limit (set by ILIM). After a minimum dead time preventing shoot through current, the low side N-channel MOSFET is turned on and the current ramps down again. As the clock cycle is completed, the low side switch is turned off and the next clock cycle starts.

In discontinuous conduction mode (DCM), the inductor current ramps to zero before the end of each clock cycle. In order to increase the efficiency the load comparator turns off the low side MOSFET before the inductor current becomes negative. This prevents reverse current flowing from the output capacitor through the inductor and low side MOSFET to ground that would cause additional losses.

As the load current decreases and the peak inductor current does not reach the power save mode threshold of typically 120 mA for more than 15 clock cycles, the converter enters a pulse frequency modulation (PFM) mode.

In the PFM mode, the converter operates with:

- Variable frequency
- Constant peak current that reduces switching losses
- Quiescent current at a minimum

Thus maintaining the highest efficiency at light load currents. In this mode, the output voltage is monitored with the error amplifier. As soon as the output voltage falls below the nominal value, the high side switch is turned on and the inductor current ramps up. When the inductor current reaches the peak current of typical: 150 mA + 50 mA/V  $\times$  (V<sub>I</sub> – V<sub>O</sub>), the high side switch turns off and the low side switch turns on. As the inductor current ramps down, the low side switch is turned off before the inductor current becomes negative which completes the cycle. When the output voltage falls below the nominal voltage again, the next cycle is started.

The converter enters the PWM mode again as soon as the output voltage can not be maintained with the typical peak inductor current in the PFM mode.

The control loop is internally compensated reducing the amount of external components.

The switch current is internally sensed and the maximum current limit can be set to typical 600 mA by connecting ILIM to ground; or, to typically 1.2 A by connecting ILIM to  $V_{\text{IN}}$ .

#### **100% Duty Cycle Operation**

As the input voltage approaches the output voltage and the duty cycle exceeds typical 95%, the converter turns the P-channel high side switch continuously on. In this mode, the output voltage is equal to the input voltage minus the voltage drop across the P-channel MOSFET.

#### **Synchronization, Power Save Mode and Forced PWM Mode**

If no clock signal is applied, the converter operates with a typical switching frequency of 750 kHz. It is possible to synchronize the converter to an external clock within a frequency range from 500 kHz to 1000 kHz. The device automatically detects the rising edge of the first clock and is synchronizes immediately to the external clock. If the clock signal is stopped, the converter automatically switches back to the internal clock and continues operation without interruption. The switch over is initiated if no rising edge on the SYNC pin is detected for a duration of four clock cycles. Therefore, the maximum delay time can be 8 µs in case the internal clock has a minimum frequency of 500 kHz.

In case the device is synchronized to an external clock, the power save mode is disabled and the device stays in forced PWM mode.



Connecting the SYNC pin to the GND pin enables the power save mode. The converter operates in the PWM mode at moderate to heavy loads and in the PFM mode during light loads maintaining high efficiency over a wide load current range.

Connecting the SYNC pin to the  $V_{IN}$  pin forces the converter to operate permanently in the PWM mode even at light or no load currents. The advantage is the converter operates with a fixed switching frequency that allows simple filtering of the switching frequency for noise sensitive applications. In this mode, the efficiency is lower compared to the power save mode during light loads (see [Figure 1](#page-1-0)).

It is possible to switch from forced PWM mode to the power save mode during operation.

The flexible configuration of the SYNC pin during operation of the device allows efficient power management by adjusting the operation of the TPS62000 to the specific system requirements.

#### **Low Noise Antiringing Switch**

An *antiringing* switch is implemented in order to reduce the EMI radiated from the converter during discontinuous conduction mode (DCM). In DCM, the inductor current ramps to zero before the end of each switching period. The internal load comparator turns off the low side switch at that instant thus preventing the current flowing backward through the inductance which increases the efficiency. An antiringing switch across the inductor prevents parasitic oscillation caused by the residual energy stored in the inductance (see [Figure 12](#page-12-0)).

#### **NOTE:**

The *antiringing* switch is only activated in the fixed output voltage versions. It is not enabled for the adjustable output voltage version TPS62000.

#### **Soft Start**

As the enable pin (EN) goes high, the soft-start function generates an internal voltage ramp. This causes the start-up current to slowly rise preventing output voltage overshoot and high inrush currents. The soft-start duration is typical 1 ms (see [Figure 13\)](#page-13-0). When the soft-start function is completed, the error amplifier is connected directly to the internal voltage reference.

#### **Enable**

Logic low on EN forces the TPS62000 into shutdown. In shutdown, the power switch, drivers, voltage reference, oscillator, and all other functions are turned off. The supply current is reduced to less than 1  $\mu$ A in the shutdown mode.

#### **Undervoltage Lockout**

An undervoltage lockout circuit provides the save operation of the device. It prevents the converter from turning on when the voltage on  $V_{IN}$  is less than typically 1.6 V.

#### **No Load Operation**

In case the converter operates in the forced PWM mode and there is no load connected to the output, the converter will regulate the output voltage by allowing the inductor current to reverse for a short period of time.

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# **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>



(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to network ground terminal.

# **RECOMMENDED OPERATING CONDITIONS**

over operating free-air temperature range (unless otherwise noted)



(1) Minimum and maximum parameters are characterized for operation at  $T_A = 210^{\circ}$ C but may not be production tested at that temperature. Production test limits with statistical guardbands are used to ensure high temperature performance.

(2) Refer to application section for further information.



# **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless oherwise noted), V<sub>I</sub> = 3.6 V, V<sub>O</sub> = 2.5 V,  $I_{\rm O}$  = 300 mA (T<sub>A</sub> = –55°C to 125°C),  $I_{\rm O}$  = 50 mA (T<sub>A</sub> = 210°C), EN = V<sub>IN</sub>



(1) Minimum and maximum parameters are characterized for operation at  $T_A = 210^{\circ}$ C but may not be production tested at that temperature. Production test limits with statistical guardbands are used to ensure high temperature performance.

(2) Measured at 50 mA.



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# **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted),  $\mathsf{V}_\mathsf{I}$  = 3.6 V,  $\mathsf{V}_\mathsf{O}$  = 2.5 V,  $I_{\rm O}$  = 300 mA (T<sub>A</sub> = –55°C to 125°C),  $I_{\rm O}$  = 50 mA (T<sub>A</sub> = 210°C), EN = V<sub>IN</sub>, ILIM = V<sub>IN</sub>



(1) Minimum and maximum parameters are characterized for operation at  $T_A = 210^{\circ}$ C but may not be production tested at that temperature.<br>Production test limits with statistical guardbands are used to ensure high tempera

(2) The output voltage accuracy includes line and load regulation over the full temperature range,  $T_A = -55^{\circ}$ C to 125°C.

 $(3)$  V<sub>IN</sub> = 5.5 V

 $(4)$  V<sub>IN</sub> = 3.3 V to 5.5 V, I<sub>O</sub> = 100 mA to 300 mA



# **[TPS62000-HT](http://focus.ti.com/docs/prod/folders/print/tps62000-ht.html)**

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# **TYPICAL CHARACTERISTICS**

## **TABLE OF GRAPHS**







**EXAS** INSTRUMENTS



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Iexas

**INSTRUMENTS** 

# **APPLICATION INFORMATION(1)**

#### **ADJUSTABLE OUTPUT VOLTAGE VERSION**

When the adjustable output voltage version (TPS62000DGS) is used, the output voltage is set by the external resistor divider (see Figure 15).

The output voltage is calculated as:

$$
V_{\rm O} = 0.45 \text{ V} \times \left(1 + \frac{\text{R1}}{\text{R2}}\right) \tag{1}
$$

With R1 + R2  $\leq$  1 M $\Omega$ 

R1 + R2 should not be greater than 1 MW because of stability reasons.

For stability reasons, a small bypass capacitor  $(C_{(m)})$  is required in parallel to the upper feedback resistor, refer to Figure 15. The bypass capacitor value can be calculated as:

$$
C_{\text{(ff)}} = \frac{1}{2\pi \times 30000 \times \text{R1}} \text{ for } C_0 < 47\mu\text{F}
$$
\n
$$
C_{\text{(ff)}} = \frac{1}{2\pi \times 5000 \times \text{R1}} \text{ for } C_0 \ge 47\mu\text{F}
$$
\n
$$
(2)
$$
\n
$$
(3)
$$

R1 is the upper resistor of the voltage divider. For  $C_{(f_1)}$ , choose a value which comes closest to the computed result.



Figure 15. Typical Application Circuit for Adjustable Output Voltage Option

#### **INDUCTOR SELECTION**

A 10-µH minimum output inductor is used with the TPS62000. Values larger than 22 µH or smaller than 10 µH may cause stability problems because of the internal compensation of the regulator.

For output voltages greater than 1.8 V, a  $22-\mu H$  inductance might be used in order to improve the efficiency of the converter.

After choosing the inductor value of typically 10 µH, two additional inductor parameters should be considered: first the current rating of the inductor and second the dc resistance.

The dc resistance of the inductance influences directly the efficiency of the converter. Therefore, an inductor with lowest dc resistance should be selected for highest efficiency.

In order to avoid saturation of the inductor, the inductor should be rated at least for the maximum output current plus the inductor ripple current which is calculated as:

(1) Application information is provided for commercial temperature as a reference and not for high temperature.

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$$
\Delta I_{L} = V_{O} \times \frac{1 - \frac{V_{O}}{V_{I}}}{L \times f} \qquad I_{L(max)} = I_{O(max)} + \frac{\Delta I_{L}}{2}
$$

Where:

 $f$  = Switching frequency (750 kHz typical)  $L = Inductor value$  $\Delta I_L$  = Peak-to-peak inductor ripple current

 $I_{L(max)}$  = Maximum inductor current

The highest inductor current occurs at maximum V<sub>1</sub>.

A more conservative approach is to select the inductor current rating just for the maximum switch current of the TPS62000 which is 1.6 A with ILIM =  $V_{IN}$  and 900 mA with ILIM = GND. See Table 1 for recommended inductors.

<b>OUTPUT CURRENT</b>	<b>INDUCTOR VALUE</b>	<b>COMPONENT SUPPLIER</b>	<b>COMMENTS</b>
$0 \text{ mA}$ to 600 mA	10 uH	Coilcraft DO3316P-103 Coilcraft DT3316P-103 Sumida CDR63B-100 Sumida CDRH5D28-100	High efficiency
		Coilcraft DO1608C-103 Sumida CDRH4D28-100 Coilcraft DO1608C-103 Murata LQH4C100K04	Smallest solution
$0 \text{ mA}$ to 300 mA			High efficiency Smallest solution
	$10 \mu H$		

Table 1. Tested Inductors<sup>(1)</sup>

(1) Parts are valid for -40°C to 85°C.

# **OUTPUT CAPACITOR SELECTION**

For best performance, a low ESR output capacitor is needed. At output voltages greater than 1.8 V, ceramic output capacitors can be used to show the best performance. Output voltages below 1.8 V require a larger output capacitor and ESR value to improve the performance and stability of the converter.





See Table 3 for recommended capacitors.

If an output capacitor is selected with an ESR value  $\leq$  120 m $\Omega$ , its RMS ripple current rating always meets the application requirements. Just for completeness, the RMS ripple current is calculated as:

$$
I_{\text{RMS}(C_{\text{O}})} = V_{\text{O}} \times \frac{1 - \frac{V_{\text{O}}}{V_{\text{I}}}}{L \times f} \times \frac{1}{2 \times \sqrt{3}}
$$

The overall output ripple voltage is the sum of the voltage spike caused by the output capacitor ESR plus the voltage ripple caused by charge and discharging the output capacitor:

$$
\Delta V_{\rm O} = V_{\rm O} \times \frac{1 - \frac{V_{\rm O}}{V_{\rm I}}}{L \times f} \times \left( \frac{1}{8 \times C_{\rm O} \times f} + \text{ESR} \right)
$$

Where the highest output voltage ripple occurs at the highest input voltage V<sub>1</sub>.

 $(4)$ 

 $(5)$ 

 $(6)$ 

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<b>CAPACITOR VALUE</b>	$ESR/m\Omega$	<b>COMPONENT SUPPLIER</b>	<b>COMMENTS</b>
10 µF	50	Taiyo Yuden JMK316BJ106KL	Ceramic
47 µF	100	Sanyo 6TPA47M	<b>POSCAP</b>
68 µF	100	Spraque 594D686X0010C2T	Tantalum

Table 3. Tested Capacitors<sup>(1)</sup>

(1) Parts are valid for -40°C to 85°C.

# **INPUT CAPACITOR SELECTION**

Because of the nature of the buck converter having a pulsating input current, a low ESR input capacitor is required for best input voltage filtering and minimizing the interference with other circuits caused by high input voltage spikes.

The input capacitor should have a minimum value of 10  $\mu$ F and can be increased without any limit for better input voltage filtering.

The input capacitor should be rated for the maximum input ripple current calculated as:

$$
I_{RMS} = I_{O(max)} \times \sqrt{\frac{V_O}{V_I} \times \left(1 - \frac{V_O}{V_I}\right)}
$$

 $(7)$ 

The worst case RMS ripple current occurs at D = 0.5 and is calculated as:  $\frac{I_{\text{RMS}}}{2} = \frac{I_0}{2}$ 

Ceramic capacitor show a good performance because of their low ESR value, and they are less sensitive against voltage transients compared to tantalum capacitors.

Place the input capacitor as close as possible to the input pin of the IC for best performance.

### **LAYOUT CONSIDERATIONS**

As for all switching power supplies, the layout is an important step in the design especially at high peak currents and switching frequencies. If the layout is not carefully done, the regulator might show stability problems as well as EMI problems.

Therefore, use wide and short traces for the main current paths as indicted in bold in Figure 16. The input capacitor should be placed as close as possible to the IC pins as well as the inductor and output capacitor. Place the bypass capacitor, C3, as close as possible to the FC pin. The analog ground, GND, and the power ground, PGND, need to be separated. Use a common ground node as shown in Figure 16 to minimize the effects of ground noise.







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# **TYPICAL APPLICATION**



(1) Use a small R-C filter to filter wrong reset signals during output voltage transitions.

(2) A large value is used for C(ff) to compensate for the parasitic capacitance introduced into the regulation loop by Q1.

**Figure 17. Dynamic Output Voltage Programming As Used in Low Power DSP Applications**

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**Figure 18. TPS62000SKGD1 Operating Life Derating Chart**

Notes:

- 1. See data sheet for absolute maximum and minimum recommended operating conditions.
- 2. Silicon operating life design goal is 10 years at 105°C junction temperature (does not include package interconnect life).

**EXAS** 

**NSTRUMENTS** 



## **PACKAGING INFORMATION**



**(1)** The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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**(3)** MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**(4)** There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

**(5)** Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

**(6)** Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE OPTION ADDENDUM**

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#### **OTHER QUALIFIED VERSIONS OF TPS62000-HT :**

• Catalog : [TPS62000](http://focus.ti.com/docs/prod/folders/print/tps62000.html)

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

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# **TUBE**



# **B - Alignment groove width**

\*All dimensions are nominal



HKK (R-CFP-F10)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
	-
	- B. This drawing is subject to change without notice.<br>C. This drawing does not comply with Mil Std 1835. Do not use this package for compliant product.
	- D. The terminals will be gold plated.



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